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Piezoelectric Materials, Devices and Integrated Systems

Guest Editors:

Message from the Guest Editors

Dr. Dongdong Chen

Dear Colleagues,

Dr. Di Li

Dr. Tianlong Zhao

Dr. Yi Quan

Special Issue with their original research articles, communications and review articles. Manuscripts will be internationally peer-reviewed. Please note that all submitted papers must be within the general scope of the Micromachines journal.

All interested researchers are invited to contribute to this

Deadline for manuscript submissions:

closed (30 January 2024)

Topics may include, but are not limited to, the following:

- Novel methods for the preparation of piezoelectric materials;
- Novel modelling and design methods of piezoelectric devices;
- Integrated circuit design for piezoelectric applications;
- Simulation and design methods of 3D-integrated systems;
- Promising applications of piezoelectric materials, devices, and integrated systems.

Dr. Dongdong Chen

Dr. Di Li

Dr. Tianlong Zhao

Dr. Yi Quan

Guest Editors













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Editor-in-Chief

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Message from the Editor-in-Chief

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